Exam.Code:0975 Sub. Code: 7426

## 1129 M. Tech. (Micro-Electronics) First Semester

MIC-106: Material Science and Engineering

Time allowed: 3 Hours

NOTE: Attempt five questions in all, including Question No. I which is compulsory and selecting two questions from each Unit.

x-x-x

- Attempt the following:-I
  - What is the difference between brass and bronze?
  - b) Define Grain and Grain boundaries.
  - What are cermets? c)
  - Why annealing is required in crystal preparation? d)
  - What are degenerate semiconductors?

(5x2)

## UNIT - I

- 11. Calculate the difference in packing densities of FCC and Zinc blende structures.
  - b) Discuss point defects. What will be effect of substitutional impurities on (2x5)electronic activity of the material?
- What happens if the mixture of two materials with different thermal expansion III. a) coefficients is cooled down?
- IV. What are the cardinal rules of creating hetero-structures? What will be the b) interface quality when two materials are having high misfit factor? (2x5)
  - How the ductile and brittle behaviour of engineering materials can be understood V. a) with Stress-stain diagram?
    - b) A material is bombarded with the highly energetic ions. What can be the processes to remove crystal imperfections occurred?

## UNIT - II

- a) What is the significance of TTT diagram? Draw .TTT diagrams for eutectoid, hypo-eutectoid and Hyper-eutectoid steels. What are the effects of carbon on VI. TTT diagram?
  - b) Discuss the construction of phase diagrams using cooling curves.

- VII. a) What is the significance of polymers matrix material in fibre-reinforced composites? Explain briefly.
  - b) How the carrier concentration of a material is dependent on the ambient temperature? What happens to the generation and recombination process if the temperature is suddenly raised? (2x5)
- (VIII. a) How the materials for optical devices are chosen? How the percentages of AlN in GaN alloy changes the wavelength of light emitted?
  - b) How direct and indirect band gap materials are useful in fabrication of different electronic devices? Discuss Photon and Phonon emissions. (2x5)